

1. General description

The 74HC540; 74HCT540 is an 8-bit inverting buffer/line driver with 3-state outputs. The device features two output enables ($\overline{OE1}$ and $\overline{OE2}$). A HIGH on \overline{OEn} causes the outputs to assume a high-impedance OFF-state. Inputs include clamp diodes. This enables the use of current limiting resistors to interface inputs to voltages in excess of V_{CC}.

2. Features and benefits

- Wide supply voltage range from 2.0 V to 6.0 V
- CMOS low power dissipation
- High noise immunity
- Latch-up performance exceeds 100 mA per JESD 78 Class II Level B
- Inverting outputs
- Input levels:
 - For 74HC540: CMOS level
 - For 74HCT540: TTL level
- Complies with JEDEC standards
 - JESD8C (2.7 V to 3.6 V)
 - JESD7A (2.0 V to 6.0 V)
- ESD protection:
 - HBM JESD22-A114F exceeds 2 kV
 - MM JESD22-A115-A exceeds 200 V
- Multiple package options
- Specified from -40 °C to +85 °C and from -40 °C to +125 °C

3. Ordering information

Table 1. Ordering information

Type number	Package								
	Temperature range	Name	Description	Version					
74HC540D 74HCT540D	-40 °C to +125 °C	SO20	plastic small outline package; 20 leads; body width 7.5 mm	<u>SOT163-1</u>					
74HC540DB	-40 °C to +125 °C	SSOP20	plastic shrink small outline package; 20 leads; body width 5.3 mm	<u>SOT339-1</u>					
74HC540PW 74HCT540PW	-40 °C to +125 °C	TSSOP20	plastic thin shrink small outline package; 20 leads; body width 4.4 mm	<u>SOT360-1</u>					

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Octal buffer/line driver; 3-state; inverting

4. Functional diagram



Octal buffer/line driver; 3-state; inverting



5. Pinning information





5.2. Pin description

Table 2. Pin description

Symbol	Pin	Description
OE1, OE2	1, 19	output enable input (active LOW)
A0, A1, A2, A3, A4, A5, A6, A7	2, 3, 4, 5, 6, 7, 8, 9	data input
GND	10	ground (0 V)
<u>70, 71, 72, 73, 74, 75, 76, 77</u>	18, 17, 16, 15, 14, 13, 12, 11	data output
V _{CC}	20	supply voltage

6. Functional description

Table 3. Functional table

H = HIGH voltage level; L = LOW voltage level; X = don't care; Z = high-impedance OFF-state.

Control		Input	Output	
OE1	OE2	An	Ϋ́n	
L	L	L	Н	
L	L	Н	L	
X	Н	Х	Z	
Н	Х	Х	Z	

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Мах	Unit
V _{CC}	supply voltage		-0.5	+7	V
I _{IK}	input clamping current	$V_{\rm I} < -0.5 \text{ V or } V_{\rm I} > V_{\rm CC} + 0.5 \text{ V}$ [1]	-	±20	mA
I _{OK}	output clamping current	$V_{\rm O} < -0.5 \text{ V or } V_{\rm O} > V_{\rm CC} + 0.5 \text{ V}$ [1]	-	±20	mA
lo	output current	$-0.5 V < V_O < V_{CC} + 0.5 V$	-	±35	mA
I _{CC}	supply current		-	70	mA
I _{GND}	ground current		-70	-	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	[2]	-	500	mW

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] For SOT163-1 (SO20) package: P_{tot} derates linearly with 12.3 mW/K above 109 °C.

For SOT339-1 (SSOP20) package: P_{tot} derates linearly with 10.0 mW/K above 100 °C.

For SOT360-1 (TSSOP20) package: P_{tot} derates linearly with 10.0 mW/K above 100 °C.

8. Recommended operating conditions

Table 5. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V)

Symbol	Parameter	Conditions	74HC540		74HCT540			Unit	
			Min	Тур	Max	Min	Тур	Max	
V _{CC}	supply voltage		2.0	5.0	6.0	4.5	5.0	5.5	V
VI	input voltage		0	-	V _{CC}	0	-	V _{CC}	V
Vo	output voltage		0	-	V _{CC}	0	-	V _{CC}	V
T _{amb}	ambient temperature		-40	+25	+125	-40	+25	+125	°C
Δt/ΔV	input transition rise and fall rate	V _{CC} = 2.0 V	-	-	625	-	-	-	ns/V
		V _{CC} = 4.5 V	-	1.67	139	-	1.67	139	ns/V
		V _{CC} = 6.0 V	-	-	83	-	-	-	ns/V

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		25 °C		-40 °C to +85 °C		-40 °C to +125 °C		Unit
			Min	Тур	Max	Min	Max	Min	Max	
74HC54	0	1								
VIH	HIGH-level	V _{CC} = 2.0 V	1.5	1.2	-	1.5	-	1.5	-	V
	input voltage	V _{CC} = 4.5 V	3.15	2.4	-	3.15	-	3.15	-	V
		V _{CC} = 6.0 V	4.2	3.2	-	4.2	-	4.2	-	V
V _{IL}	LOW-level	V _{CC} = 2.0 V	-	0.8	0.5	-	0.5	-	0.5	V
	input voltage	V _{CC} = 4.5 V	-	2.1	1.35	-	1.35	-	1.35	V
		V _{CC} = 6.0 V	-	2.8	1.8	-	1.8	-	1.8	V
V _{OH}	HIGH-level	V _I = V _{IH} or V _{IL}								
	output voltage	ge I _O = -20 μA; V _{CC} = 2.0 V		2.0	-	1.9	-	1.9	-	V
		I _O = -20 μA; V _{CC} = 4.5 V	4.4	4.5	-	4.4	-	4.4	-	V
		I _O = -20 μA; V _{CC} = 6.0 V	5.9	6.0	-	5.9	-	5.9	-	V
		I _O = -6.0 mA; V _{CC} = 4.5 V	3.98	4.32	-	3.84	-	3.7	-	V
		I _O = -7.8 mA; V _{CC} = 6.0 V	5.48	5.81	-	5.34	-	5.2	-	V
V _{OL}	LOW-level output voltage	V _I = V _{IH} or V _{IL}								
		I _O = 20 μA; V _{CC} = 2.0 V	-	0	0.1	-	0.1	-	0.1	V
		I _O = 20 μA; V _{CC} = 4.5 V	-	0	0.1	-	0.1	-	0.1	V
	I _O = 20 μA; V _{CC} =		-	0	0.1	-	0.1	-	0.1	V
		I _O = 6.0 mA; V _{CC} = 4.5 V	-	0.15	0.26	-	0.33	-	0.4	V
		I _O = 7.8 mA; V _{CC} = 6.0 V	-	0.16	0.26	-	0.33	-	0.4	V
l _l	input leakage current	$V_{I} = V_{CC}$ or GND; $V_{CC} = 6.0$ V	-	-	±0.1	-	±1.0	-	±1.0	μA
I _{OZ}	OFF-state output current	$V_{I} = V_{IH} \text{ or } V_{IL}; V_{CC} = 6.0 \text{ V};$ $V_{O} = V_{CC} \text{ or GND}$	-	±0.5	-	±5.0	-	±10	-	μA
I _{CC}	supply current	$V_1 = V_{CC}$ or GND; $I_0 = 0$ A; $V_{CC} = 6.0$ V	-	-	8.0	-	80	-	160	μA
CI	input capacitance		-	3.5	-	-	-	-	-	pF
74HCT5	40					<u> </u>				
V _{IH}	HIGH-level input voltage	V _{CC} = 4.5 V to 5.5 V	2.0	1.6	-	2.0	-	2.0	-	V
V _{IL}	LOW-level input voltage	V _{CC} = 4.5 V to 5.5 V	-	1.2	0.8	-	0.8	-	0.8	V
V _{OH}	HIGH-level	$V_{I} = V_{IH} \text{ or } V_{IL}; V_{CC} = 4.5 \text{ V}$								
	output voltage	I _O = -20 μA	4.4	4.5	-	4.4	-	4.4	-	V
		I _O = -6.0 mA	3.98	4.32	-	3.84	-	3.7	-	V
V _{OL}	LOW-level	$V_{I} = V_{IH}$ or V_{IL} ; $V_{CC} = 4.5 V$								
	output voltage	I _O = 20 μA;	-	0	0.1	-	0.1	-	0.1	V
		I _O = 6.0 mA;	_	0.16	0.26	-	0.33	-	0.4	V

Octal buffer/line driver; 3-state; inverting

Symbol	Parameter	Conditions		25 °C		-40 °C t	o +85 °C	-40 °C to	• +125 ℃	Unit
			Min	Тур	Max	Min	Max	Min	Max	
lı	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 5.5 V$	-	-	±0.1	-	±1.0	-	±1.0	μA
I _{OZ}	OFF-state output current	$V_I = V_{IH} \text{ or } V_{IL}; V_{CC} = 5.5 \text{ V};$ $V_O = V_{CC} \text{ or GND}$	-	-	±0.5	-	±5.0	-	±10	μA
I _{CC}	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 5.5$ V	-	-	8.0	-	80	-	160	μA
00	additional supply current	per input pin; $I_0 = 0 A$; V _I = V _{CC} - 2.1 V; other inputs at V _{CC} or GND; V _{CC} = 4.5 V to 5.5 V								
		An input	-	140	504	-	630	-	686	μA
		OE1 input	-	150	540	-	675	-	735	μA
		OE2 input	-	100	360	-	450	-	490	μA
Cı	input capacitance		-	3.5	-	-	-	-	-	pF

10. Dynamic characteristics

Table 7. Dynamic characteristics

GND = 0 V; $C_L = 50 pF$; for test circuit see Fig. 7.

Symbol	Parameter	Conditions		25 °(2	-40 °C to 85 °C	-40 °C to +125 °C	Unit
				ו Typ	Max	Max	Max	
74HC54	0					1	1	
t _{pd}	propagation	An to Yn; see Fig. 5 [1]						
	delay	V _{CC} = 2.0 V	-	30	100	125	150	ns
		V _{CC} = 4.5 V	-	11	20	25	30	ns
		V _{CC} = 5.0 V; C _L = 15 pF	-	9	-	-	-	ns
		V _{CC} = 6.0 V		9	17	21	26	ns
t _{en} e	enable time	OEn to Yn; see Fig. 6	[1]					
		V _{CC} = 2.0 V	-	52	160	200	240	ns
		V _{CC} = 4.5 V		19	32	40	48	ns
		V _{CC} = 6.0 V	-	15	27	34	41	ns
t _{dis}	disable time	OEn to Yn; see Fig. 6	[1]					
		V _{CC} = 2.0 V	-	61	160	200	240	ns
		V _{CC} = 4.5 V	-	22	32	40	48	ns
		V _{CC} = 6.0 V	-	18	27	34	41	ns
t _t	transition time	see Fig. 5	[2]					
		V _{CC} = 2.0 V	-	14	60	75	90	ns
		V _{CC} = 4.5 V	-	5	12	15	18	ns
		V _{CC} = 6.0 V	-	4	10	13	15	ns
C _{PD}	power dissipation capacitance	per package; V _I = GND to V _{CC}	[3] -	39	-	-	-	pF

74HC_HCT540

Octal buffer/line driver; 3-state; inverting

Symbol	Parameter	Conditions		25 °C		-40 °C to 85 °C	-40 °C to +125 °C	Unit
				Тур	Max	Мах	Мах	1
74HCT5	40	1						
t _{pd}	propagation	An to Yn; see Fig. 5 [1]					
de	delay	V _{CC} = 4.5 V	-	13	24	30	36	ns
		V _{CC} = 5.0 V; C _L = 15 pF	-	11	-	-	-	ns
t _{en} er	enable time	OEn to Yn; see Fig. 6 [1]					
		V _{CC} = 4.5 V	-	22	35	44	53	ns
t _{dis}	disable time	OEn to Yn; see Fig. 6 [1]					
		V _{CC} = 4.5 V	-	23	35	44	53	ns
t _t	transition time	V _{CC} = 4.5 V; see <u>Fig. 5</u> [2	-	5	12	15	18	ns
C _{PD}	power dissipation capacitance	per package; [3 V_I = GND to V_{CC} - 1.5 V] -	44	-	-	-	pF

[1] t_{pd} is the same as t_{PLH} and t_{PHL} . $t_{en} \mbox{ is the same as } t_{PZL} \mbox{ and } t_{PZH}.$

 t_{dis} is the same as t_{PLZ} and $t_{\text{PHZ}}.$

[2] t_t is the same as t_{THL} and t_{TLH} . [3] C_{PD} is used to determine the dynamic power dissipation (P_D in μ W): $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \sum (C_L \times V_{CC}^2 \times f_o)$ where: f_i = input frequency in MHz; f_o = output frequency in MHz; C_L = output load capacitance in pF;

V_{CC} = supply voltage in V;

N = number of inputs switching;

 $\sum (C_L \times V_{CC}^2 \times f_o) = \text{sum of outputs.}$

Octal buffer/line driver; 3-state; inverting



10.1. Waveforms and test circuit

Measurement points are given in <u>Table 8</u>.

V_{OL} and V_{OH} are typical voltage output levels that occur with the output load.

outputs

enabled

Fig. 6. 3-state enable and disable times

Table 8. Measurement points

Туре	Input	Output					
	V _M	V _M V _X V _Y					
74HC540	0.5V _{CC}	0.5V _{CC}	0.1V _{CC}	0.9V _{CC}			
74HCT540	1.3 V	1.3 V	0.1V _{CC}	0.9V _{CC}			

outputs

disabled

outputs

enabled

Octal buffer/line driver; 3-state; inverting



Fig. 7. Test circuit for measuring switching times

Table 9. Test data

Туре	Input		Load		S1 position		
	VI	t _r , t _f	CL	RL	t _{PHL} , t _{PLH}	t _{PZH} , t _{PHZ}	t _{PZL} , t _{PLZ}
74HC540	V _{CC}	6 ns	15 pF, 50 pF	1 kΩ	open	GND	V _{CC}
74HCT540	3 V	6 ns	15 pF, 50 pF	1 kΩ	open	GND	V _{CC}

11. Package outline



Fig. 8. Package outline SOT163-1 (SO20)

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Fig. 9. Package outline SOT339-1 (SSOP20)

Octal buffer/line driver; 3-state; inverting



Fig. 10. Package outline SOT360-1 (TSSOP20)

⁷⁴HC_HCT540

12. Abbreviations

Table 10. Abbreviations				
Acronym	Description			
CMOS	Complementary Metal-Oxide Semiconductor			
DUT	Device Under Test			
ESD	ElectroStatic Discharge			
НВМ	Human Body Model			
ММ	Machine Model			
TTL	Transistor-Transistor Logic			

13. Revision history

Table 11. Revision history						
Document ID	Release date	Data sheet status	Change notice	Supersedes		
74HC_HCT540 v.7	20240507	Product data sheet	-	74HC_HCT540 v.6		
Modifications:	Type number	Type number 74HCT540DB (SOT339-1/SSOP20) removed.				
74HC_HCT540 v.6	20211019	Product data sheet	-	74HC_HCT540 v.5		
Modifications:	Type number	Type number 74HCT540PW (SOT360-1/TSSOP20) added.				
74HC_HCT540 v.5	20210816	Product data sheet	-	74HC_HCT540 v.4		
Modifications:	 The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia. Legal texts have been adapted to the new company name where appropriate. Type number 74HC540PW (SOT360-1/TSSOP20) added. Section 2 updated. Section 7: Derating values for P_{tot} total power dissipation updated. 					
74HC_HCT540 v.4	20160301	Product data sheet	-	74HC_HCT540 v.3		
Modifications:	Type numbers 74HC540N and 74HCT540N (SOT146-1) removed.					
74HC_HCT540 v.3	20130121	Product data sheet	-	74HC_HCT540_CNV v.2		
Modifications:	 The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors. Legal texts have been adapted to the new company name where appropriate. 					
74HC_HCT540_CNV v.2	19970905	Product specification	-	_		

14. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
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